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January 2009

MM74HC174 — Hex D-Type Flip-Flops with Clear

Features

Typical Propagation Delay: 16ns

Wide Operating Voltage Range: 2V–6V

Low Input Current: 1µA maximum

■ Low Quiescent Current: 80µA (74HC Series)

Output Drive: 10 LSTTL Loads

Description

The MM74HC174 edge-triggered flip-flops utilize silicon-gate CMOS technology to implement D-type flip-flops. They possess high noise immunity, low-power, and speeds comparable to low-power Schottky TTL circuits. This device contains six master-slave flip-flops with a common clock and common clear. Data on the D input with the specified setup and hold times is transferred to the Q output on the LOW-to-HIGH transition of the CLOCK input. When LOW, the input sets all outputs to a LOW state.

Each output can drive ten low-power Schottky TTL equivalent loads. The MM74HC174 is functionally and pin comparable to the 74LS174. All inputs are protected from damage due to static discharge by diodes to $V_{\rm CC}$ and ground.

Ordering Information

Part Number	Operating Temperature Range	© Eco Status	Package	Packing Method
MM74HC174M	-40 to +85°C		16-Lead Small Outline Integrated Circuit	Tubes
MM74HC174MX	-40 to +85°C	RoHS	(SOIC), JEDEC MS-012, 0.150 Inch Narrow	Tape and Reel
MM74HC174MTC	-40 to +85°C		16 Load Thin Shrink Small Outline Backage	Tubes
MM74HC174MTCX	-40 to +85°C	RoHS	HS 16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide	
MM74HC174N	-40 to +85°C	RoHS	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Inch Wide	Tubes

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Pin Configuration

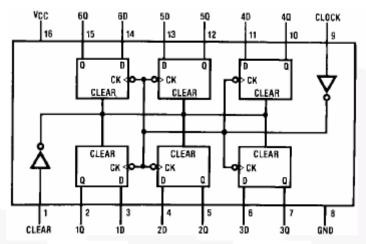


Figure 1. Pin Configuration (Top View)

Truth Table (Each Flip-Flop)

	Inputs					
Clear	Clear Clock D		Ø			
LOW	Don't Care	Don't Care	LOW			
HIGH	↑ ⁽¹⁾	HIGH	HIGH			
HIGH	↑ ⁽¹⁾	LOW	LOW			
HIGH	LOW	Don't Care	Q ₀ ⁽²⁾			

Notes:

- Transition from LOW to HIGH level.
- The level of Q before the indicated steady-state input conditions were established.

Logic Diagram

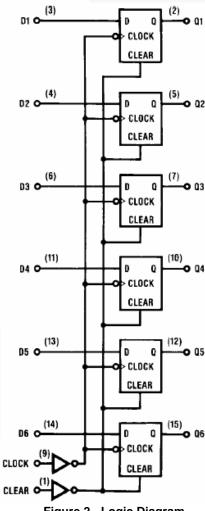


Figure 2. Logic Diagram

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Unless otherwise noted, all voltages are referenced to ground.

Symbol	Parameter		Min.	Max.	Unit
Vcc	Supply Voltage		-0.5	+7.0	V
V _{IN}	DC Input Voltage		-1.5 to V _{CC}	+1.5	V
V _{OUT}	DC Output Voltage		-0.5 to V _{CC}	+0.5	V
I _{IK} , I _{OK}	Clamp Diode Current			±20	mA
I _{OUT}	DC Output Current, per Pin			±25	mA
I _{CC}	DC V _{CC} or GND Current, per Pin			±50	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
PD	Power Dissipation ⁽³⁾	TSSOP, PDIP		600	mW
PD	SOIC			500	IIIVV
TL	Lead Temperature, Soldering10 Seconds			260	°C

Notes:

3. Power dissipation temperature derating—plastic "N" package:12mW/°C from 65° to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
Vcc	Supply Voltage		2	6	V
V_{IN}, V_{OUT}	DC Input or Output Voltage		0	V_{CC}	V
T _A	Operating Temperature Range		-40	+85	°C
		V _{CC} =2.0V		1000	ns
t _r , t _f Input Rise and Fall Times	V _{CC} =4.5V		500	ns	
	V _{CC} =6.0V		400	ns	

DC Electrical Characteristics⁽⁴⁾

Symbol	Parameter	Conditions	V _{cc} (V)	T _A =2	25°C	T _A =-40 to+85°C	T _A =-55 to +125°C	Units
			()	Тур.	Typ. Guaranteed Limits			
			2.0		1.5	1.5	1.5	
V _{IH}	Minimum HIGH Level Input		4.5		3.15	3.15	3.15	V
			6.0		4.2	4.2	4.2	
			2.0		0.5	0.5	0.5	
V_{IL}	Minimum LOW Level Input		4.5		1.35	1.35	1.35	V
			6.0		1.8	1.8	1.8	
		M M	2.0	2.0	1.9	1.9	1.9	
		$V_{IN}=V_{IH}$ or V_{IL} , $ I_{OUT} \le 20\mu A$	4.5	4.5	4.4	4.4	4.4	
	Minimum HIGH Level Output		6.0	6.0	5.9	5.9	5.9	
V _{OH}	VoH Voltage	$V_{IN}=V_{IH}$ or V_{IL} , $ I_{OUT} \le 4.0$ mA	4.5	4.20	3.98	3.84	3.70	V
		$V_{IN}=V_{IH}$ or V_{IL} , $\left I_{OUT} \right \le 5.2 mA$	6.0	5.70	5.48	5.34	5.20	
		., .,	2.0	0	0.1	0.1	0.1	
		$V_{IN}=V_{IH}$ or V_{IL} , $ I_{OUT} \le 20\mu A$	4.5	0	0.1	0.1	0.1	
	Minimum LOW Level Output	VIL, 110011 = 20μ/τ	6.0	0	0.1	0.1	0.1	
V _{OL}	Vol. Voltage	$V_{IN}=V_{IH}$ or V_{IL} , $ I_{OUT} \le 4.0$ mA	4.5	00.2	0.26	0.33	0.40	V
		$V_{IN}=V_{IH}$ or V_{IL} , $\left I_{OUT} \right \le 5.2 mA$	6.0	0.20	0.26	0.33	0.40	
I _{IN}	Maximum Input Current	V _{IN} =V _{CC} or GND	6.0		±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	V _{IN} =V _{CC} or GND, I _{OUT} =0µA	6.0		8	80	160	μΑ

Note:

4. For a power supply of 5V $\pm 10\%$, the worst-case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5V. The 4.5V values should be used when designing with this supply. Worst-case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V, respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst-case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occurs for CMOS at the higher voltage, so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$ and $C_L = 15pF$, $t_r = t_f = 6ns$.

Symbol	Parameter	Тур.	Guaranteed Limit	Unit
f _{MAX}	Maximum Operating Frequency	50	30	MHz
t_{PHL}, t_{PLH}	Maximum Propagation Delay, Clock, or Clear to Output	16	30	ns
t _{REM}	Minimum Removal Time, Clear to Clock	-2	5	ns
ts	Minimum Setup Time, Data to Clock		20	ns
t _H	Minimum Hold Time, Clock to Data		5	ns
t _W	Minimum Pulsewidth, Clock or Clear	10	16	ns

AC Electrical Characteristics(5)

 $C_L = 50 pF$, $t_r = t_f = 6 ns$ unless otherwise noted.

Symbol	Parameter	V _{cc} (V)	T _A =2	5°C	T _A =-40 to+85°C	T _A =-55 to +125°C	Units
			Тур.	(Suaranteed L		
		2.0		5	4	3	
f_{MAX}	Maximum Operating Frequency	4.5		27	21	18	MHz
		6.0		31	24	20	N
		2.0	55	165	206	248	
t_{PHL}, t_{PLH}	Maximum Propagation Delay, Clock, or Clear to Output	4.5	18	33	41	49	ns
	or oldar to output	6.0	16	28	35	42	
		2.0	1	5	5	5	
t _{REM}	Minimum Setup Time, Data to Clock	4.5	1	5	5	5	ns
		6.0	1	5	5	5	
		2.0	42	100	125	150	
ts	Minimum Setup Time, Data to Clock	4.5	12	20	25	30	ns
		6.0	10	17	21	25	
		2.0	1	5	5	5	ns
t _H	Minimum Hold Time, Clock to Data	4.5	1	5	5	5	
		6.0	1	5	5	5	
		2.0	35	80	106	120	
tw	Minimum Pulse Width, Clock or Clear	4.5	10	16	20	24	ns
		6.0	8	14	18	20	
		2.0	30	75	95	110	
t_{TLH}, t_{THL}	Maximum Output Rise and Fall Time	4.5	8	15	19	22	ns
		6.0	7	13	16	19	∇J
t _r ,t _f Maxir		2.0		1000	1000	1000	ns
	Maximum Input Rise and Fall Time	4.5		500	500	500	
		6.0		400	400	400	1
C_{PD}	Power Dissipation Capacitance ⁽⁵⁾ (per Package)		136				pF
C _{IN}	Maximum Input Capacitance		5	10	10	10	pF

Note:

5. C_{PD} determines the no-load dynamic power consumption, P_D = C_{PD} V_{CC}² f + I_{CC} V_{CC}, and the no-load dynamic current consumption, I_S = C_{PD} V_{CC} f + I_{CC}.

AC Waveforms

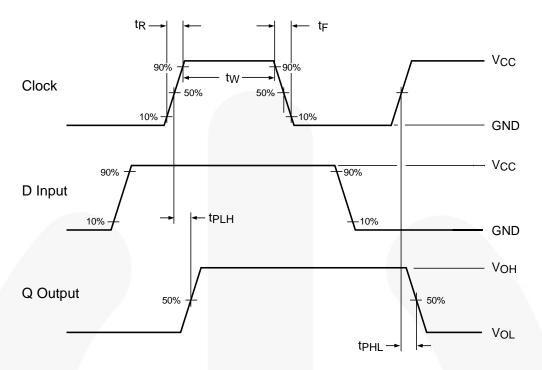


Figure 3. AC Waveform

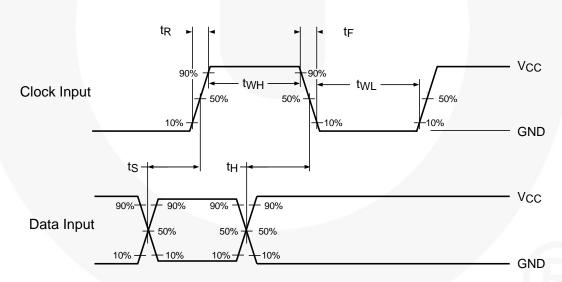


Figure 4. AC Waveform

Physical Dimensions

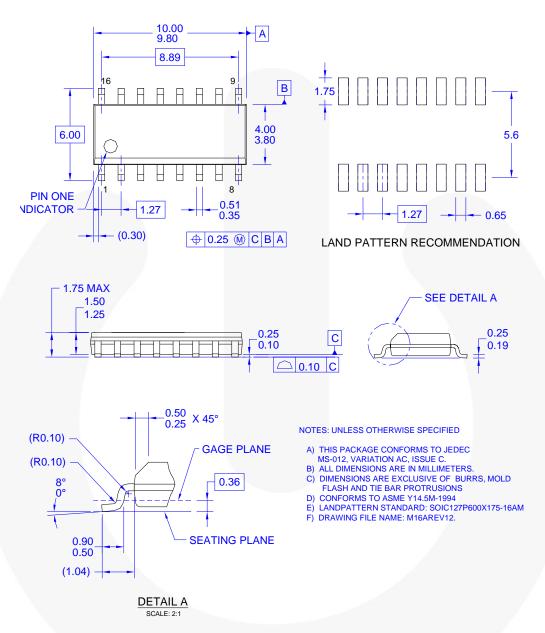


Figure 5. 16-Lead, Small Outline Integrated Circuit (SOIC)

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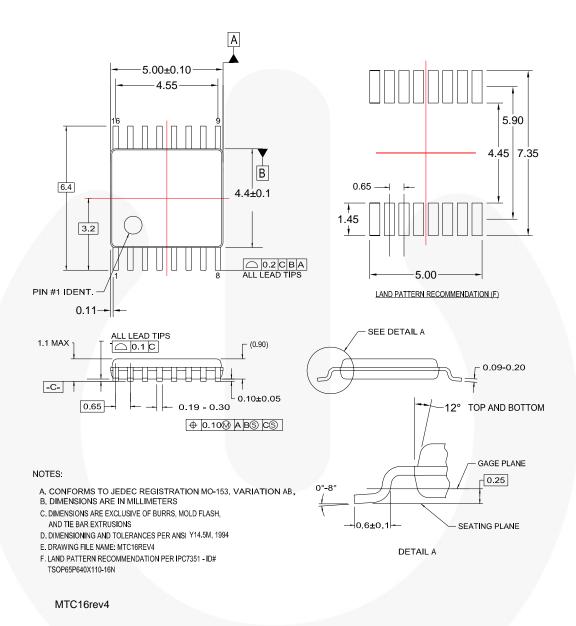
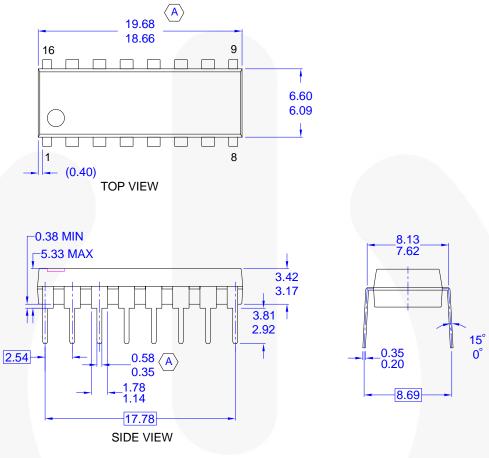


Figure 6. 16-Lead Thin Shrink Small Outline Package (TSSOP)

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Figure 7. 16-Lead Plastic Dual-In-Line Package (PDIP)

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